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Substitute for form 1449A/PTO				<b>Application Number</b>	09/652,730
<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)				<b>Filing Date</b>	08/31/2000
				<b>First Named Inventor</b>	William B. Boyle
				<b>Art Unit</b>	2615
				<b>Examiner Name</b>	Christopher O. Onuaku
				<b>Attorney Docket Number</b>	K35A0665
Sheet	1	of	2		

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Examiner Signature	CHRISTOPHER QUAKY	Date Considered	1/13/03
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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